

E160-6U-3

Width/Thick:
Height:
16-Pin DIP Capacity:
Material:
Wire-Wrap Terminals:
Wire-Wrap Socket Pins:
Rec. Card Cage:

96-Pin Din Connector:

Circuit Pattern:

Hole Diameter:

6U X 160MM

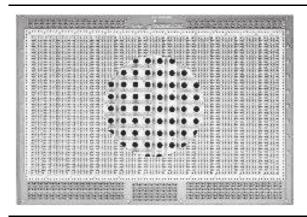
Voltage/Ground Plane
6.30"/.062"
9.19"
105
FR4 Epoxy Glass
T44, T46, T49, T68
R50, R51, R52, R53
CCK160-6U
RE96MWR
(Available Separately)

 Overall voltage and ground planes on opposite board sides provide excellent shielding and power distribution

To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 eye lets, available separately) for use without pins)

 Layout paper and instructions included

 Row and column legends provided



4615

Circuit Pattern:
Width/Thick:
Height:
16-Pin DIP Capacity:
Material:
Wire-Wrap Terminals:
Wire-Wrap Socket Pins:

Rec. Card Cage: 96-Pin Din Connector:

Hole Diameter:

6U X 160MM

3-Hole Solder Pad 6.30"/.062" 9.19" 50

.055"

FR4 Epoxy Glass T44, T46, T49, T68 R32

CCK160-6U RE96MWR

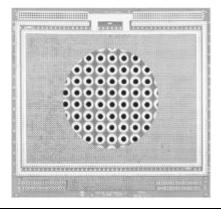
(Available Separately) provided .042"

 3-hole solder pads (0.28" x 0.080") for interconnecting multiple component leads

Bus and pad surfaces soldercoated for user convenience Interleaved buses on both sides, back-to-back

Layout paper and instructions included

Row and column legends
 provided



E220-6U-1

Circuit Pattern: Width/Thick: Height: 16-Pin DIP Capacity: Material:

Wire-Wrap Terminals: Wire-Wrap Socket Pins: Rec. Card Cage: 96-Pin Din Connector:

Hole Diameter:

6U X 220MM

8.66"/0.62" 9.19" 140 FR4 Epoxy Glass T44, T46, T49, T68

Pad-per-hole

T44, T46, T49, T68 R32 CCK220-6U

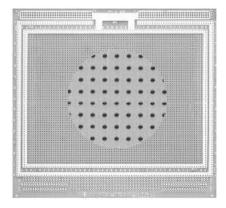
RE96MWR (Available Separately) .042" Plated-thru holes

Voltage and ground buses around board perimeter both sides

 Pad and Bus surfaces soldercoated for user convenience

Also accepts PGA 's and PLCC's
 Layout paper and instructions included

 Row and column legends provided



E220-6U-2

Circuit Pattern:

Width/Thick:
Height:
16-Pin DIP Capacity:
Material:
Wire-Wrap Terminals:
Wire-Wrap Socket Pins:
Rec. Card Cage:
96-Pin Din Connector:

Hole Diameter:

6U X 220MM

Peripheral Buses • 8.66"/.062" 9.19" 140 FR4 Epoxy Glass T44, T46, T49, T68 •

R32

CCK220-6U • RE96MWR (Available Separately)* .042"

 Voltage and ground buses around board perimeter both

 Bus surfaces solder-coated for user convenience

Also accepts PGA 's and PLCC's 58 x 78 grid unrestricted component placement area

Layout paper and instructions includedRow and column legends

provided



E220-6U-3 **6U X 220MM**

Circuit Pattern: Width/Thick: Height:

16-Pin DIP Capacity:

Material:

Wire-Wrap Terminals: Wire-Wrap Socket Pins: Rec. Card Cage: 96-Pin Din Connector:

Hole Diameter:

Voltage/Ground plane * 8.66"/.062" 9.19"

168

FR4 Epoxy Glass T44, T46, T49, T68 R50, R51, R52, R53 CCK220-6U

RE96MWR (Available Separately)

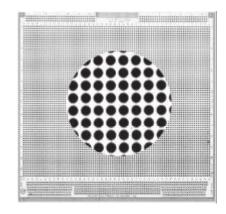
.055"

Overall voltage and ground planes on opposite board sides provide excellent shielding and power distribution

Plane surfaces solder-coated for user convenience

To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 eyelets, available separately (for use without pins)

Layout paper and instructions included



E280-9U-1

Hole Diameter:

Circuit Pattern:

Width/Thick: Height:

16-Pin DIP Capacity:

Material:

Wire-Wrap Terminals: Wire-Wrap Socket Pins:

Rec. Card Cage: 96-Pin Din Connector:

9U X 280MM

.042"

Pad-Per-Hole

11.02"/.062" 14.44"

270 FR4 Epoxy Glass

T44, T46, T49, T68 R32

CCK280-9U RE96MWR

(Available Separately)

· Voltage and ground buses around board perimeter both

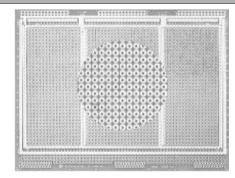
Accepts PGA and PLCC devices

Additional power and ground buses in signal area

Layout paper and instructions included

Row and column legends provided

Plated-thru holes



E280-9U-2

Circuit Pattern: Width/Thick: Height:

16-Pin DIP Capacity:

Material:

Wire-Wrap Terminals: Wire-Wrap Socket Pins: Rec. Card Cage:

96-Pin Din Connector: Hole Diameter:

9U X 280MM

11.02/.062" 14.44"

270

FR4 Epoxy Glass T44, T46, T49, T68

R32

.042"

CCK280-9U RE96MWR

Peripheral Buses • Voltage and ground buses around board perimeter both sides

> · Bus surfaces solder-coated for user convenience

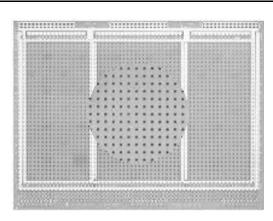
Capacity for mounting 270, 16pin DIP IC devices; also accepts PGA and PLCC devices

Additional power and ground buses in signal area

Three 79 x 36 grid unrestricted component placement areas

Layout paper and instructions included

Row and column legends provided



E280-9U-3

Circuit Pattern: Width/Thick: Heiaht:

16-Pin DIP Capacity:

Material:

Wire-Wrap Terminals: Wire-Wrap Socket Pins: Rec. Card Cage: 96-Pin Din Connector: **Hole Diameter:**

9U X 280MM

Voltage/Ground Plane 11.02/.062" 14.44" 348

FR4 Epoxy Glass T44, T46, T49, T68 R50, R51, R52, R53 CCK280-9U RE96MWR

.055"

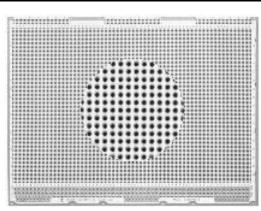
 Overall voltage and ground planes on opposite board sides provide excellent shielding and power distribution

Additional power and ground buses in signal area

To simulate plated-thru holes committed to voltage or ground planes, use Vector T123 evelets, available separately (for use without pins)

Layout paper and instructions included

Row and column legends provided



Web site: http://www.vectorelect.com ELECTRONIC COMPAN